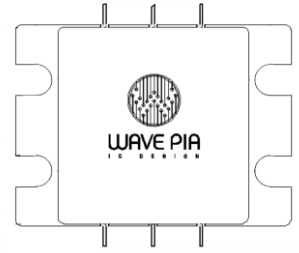


### Product Features

- High Power GaN HEMT for 5.7 to 6.7GHz
- 12.19dB Small Signal Gain at 6.2GHz
- 44.86dBm Typical  $P_{SAT}$  at 6.2GHz
- 51.1% Efficiency at  $P_{SAT}$  at 6.2GHz
- 28V Operation

### Applications

- Point to Point / Multipoint Radio
- Test Equipment & Industrial Controls
- SATCOM
- Military End-Use
- C-band Radar



Package Type: 680BH

### Absolute Maximum Rating

Parameter	Symbol	Rating	Units	Conditions
Drain-Source Voltage	$V_{DSS}$	160	Volts	25°C
Gate-to-Source Voltage <sup>3</sup>	$V_{GS}$	-10, +2	Volts	25°C
Storage Temperature <sup>3</sup>	$T_{STG}$	-65, +150	°C	
Operating Junction Temperature <sup>1,3</sup>	$T_J$	225	°C	
Maximum Forward Gate Current <sup>3</sup>	$I_{GMAX}$	30	mA	25°C
Maximum Drain Current <sup>2</sup>	$I_{DMAX}$	1	A	$I_d @ V_d = 10V, V_g = 1V$
Soldering Temperature <sup>3</sup>	$T_S$	245	°C	

1. Continuous use at maximum temperature will affect MTTF.
2. Current limit for long term, reliable operation.
3. After additional updates.

### DC Characteristics<sup>1</sup> ( $T_c = 25^\circ\text{C}$ )

Parameter	Symbol	MIN	TYP	MAX	Units	Conditions
Gate Threshold Voltage	$V_{GS(th)}$		-3.5		$V_{DC}$	$V_{DS} = 10V, I_D = 1mA$
Gate Quiescent Voltage	$V_{GS(Q)}$		-2.3		$V_{DC}$	$V_{DS} = 28V, I_D = 200mA$
Saturated Drain Current <sup>2</sup>	$I_{DS}$		2000		mA/mm	$V_{DS} = 10V, V_{GS} = 1V$
Drain-Source Breakdown Voltage	$V_{BR}$	160			$V_{DC}$	$I_D = 1 \text{ mA/mm}$

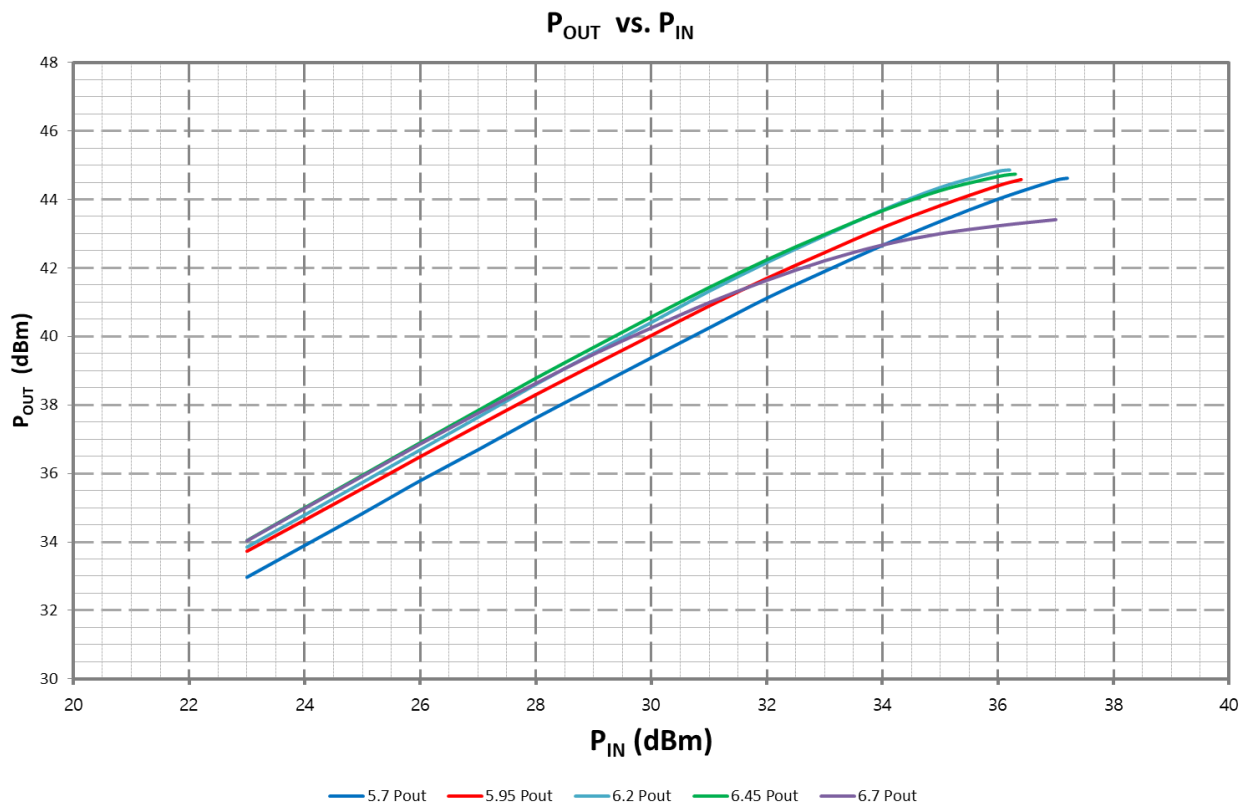
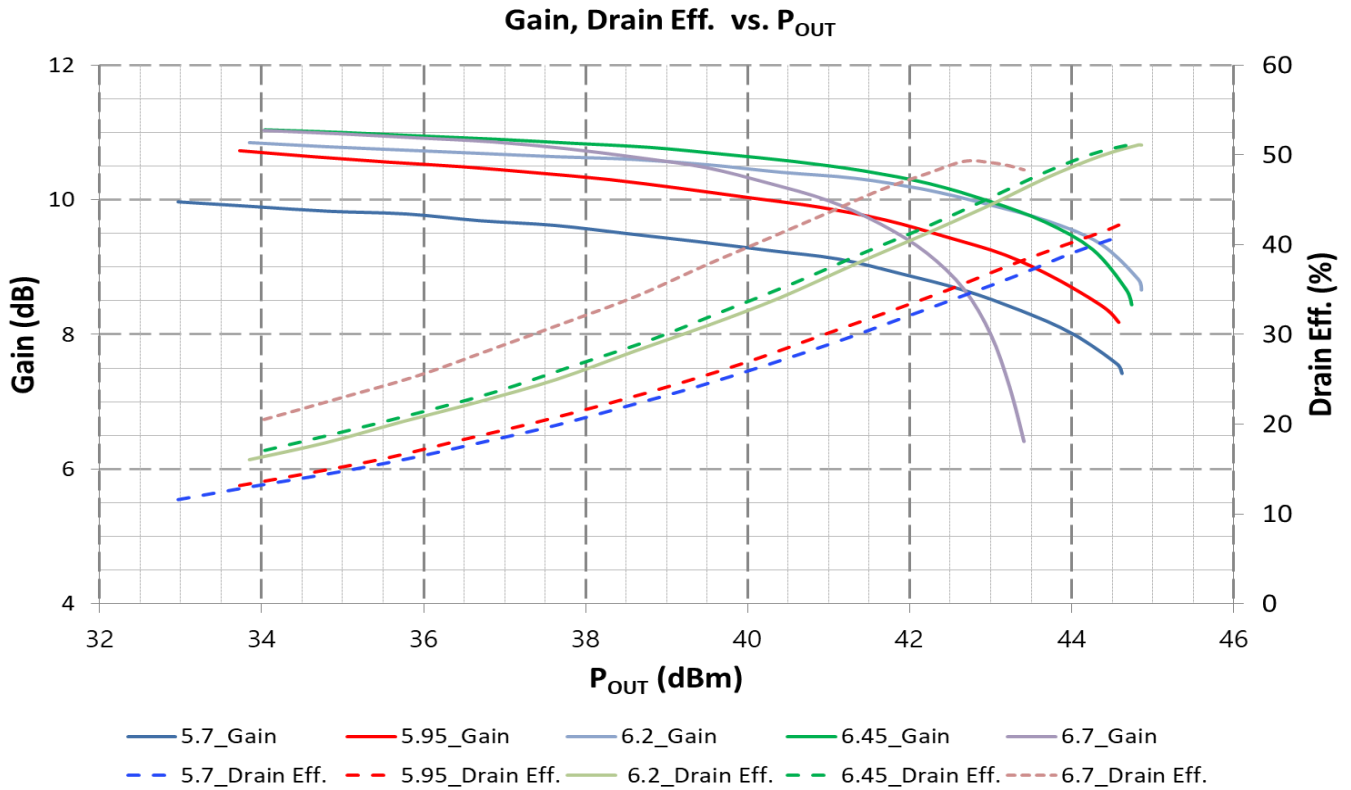
1. Measured on wafer prior to packaging.
2. Scaled from PCM data.

### RF Characteristics ( $T_c = 25^\circ\text{C}$ , $F_0 = 6.2\text{GHz}$ , Unless otherwise noted)

Parameter	Symbol	MIN	TYP	MAX	Units	Conditions
Gain	$G_{SS}$		10.85		dB	$V_{DD} = 28V, I_{DQ} = 200mA, \text{RF CW}$
Saturated Output Power	$P_{SAT}$		44.85		dBm	$V_{DD} = 28V, I_{DQ} = 200mA, \text{RF CW}$
Pulsed Drain Efficiency <sup>1</sup>	$\eta$		51.1		%	$V_{DD} = 28V, I_{DQ} = 200mA, \text{RF CW @ } P_{SAT}$

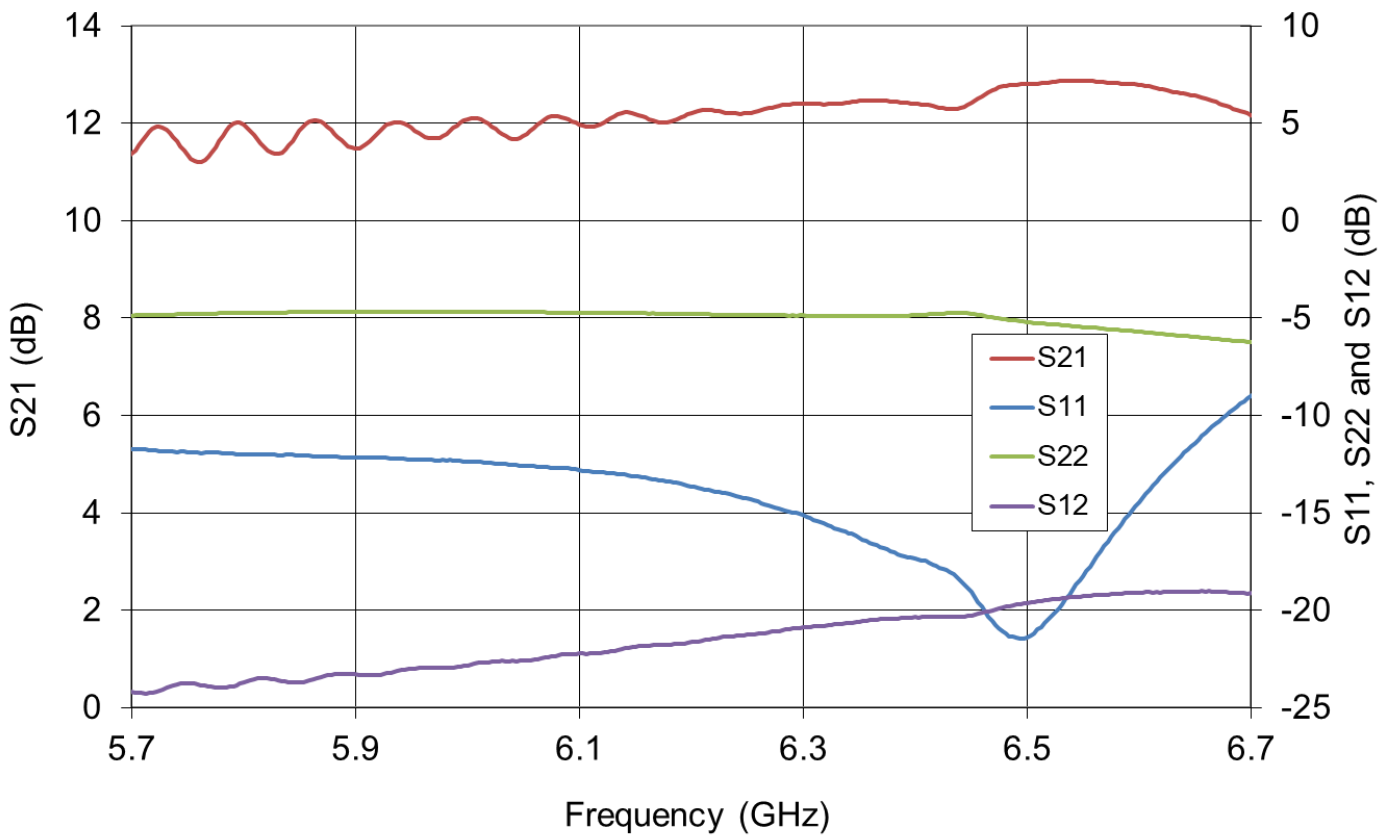
1. Drain Efficiency =  $P_{OUT} / P_{DC}$

**CW Signal Performance (Tc=25°C, Measured in the test board amplifier circuit)**  
 VDD=28V, IDQ=200mA, RF CW

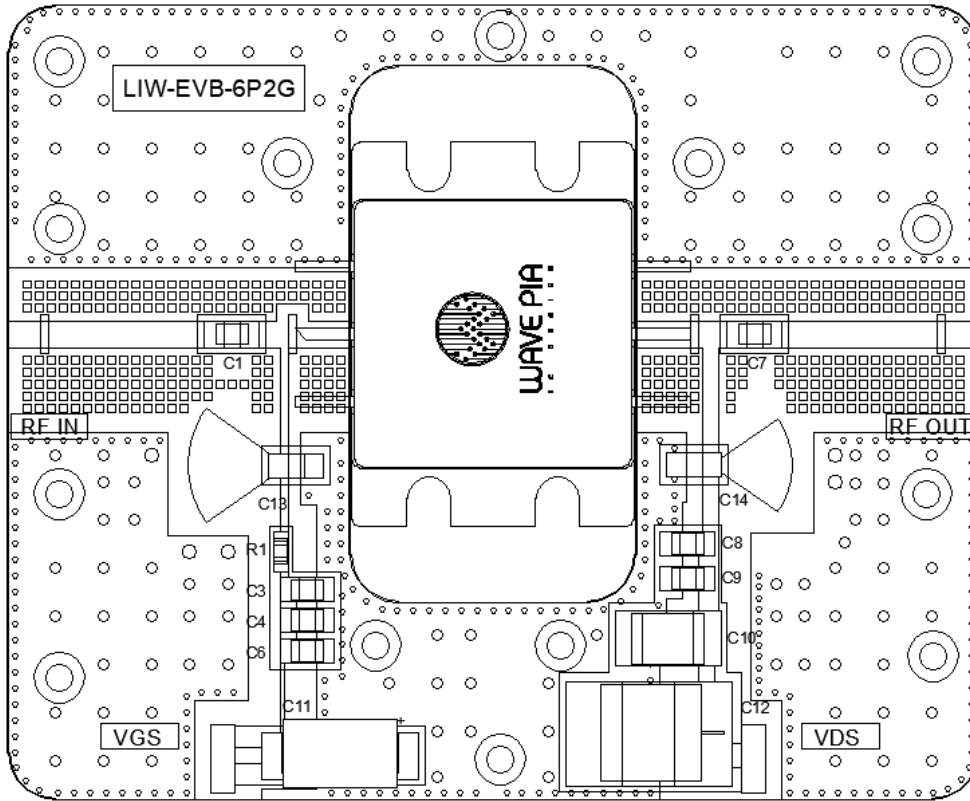


**Small Signal Performance (Tc=25°C, Measured in the test board amplifier circuit)**  
 VDD=28V, IDQ=200mA

S-parameters (dB) versus frequency



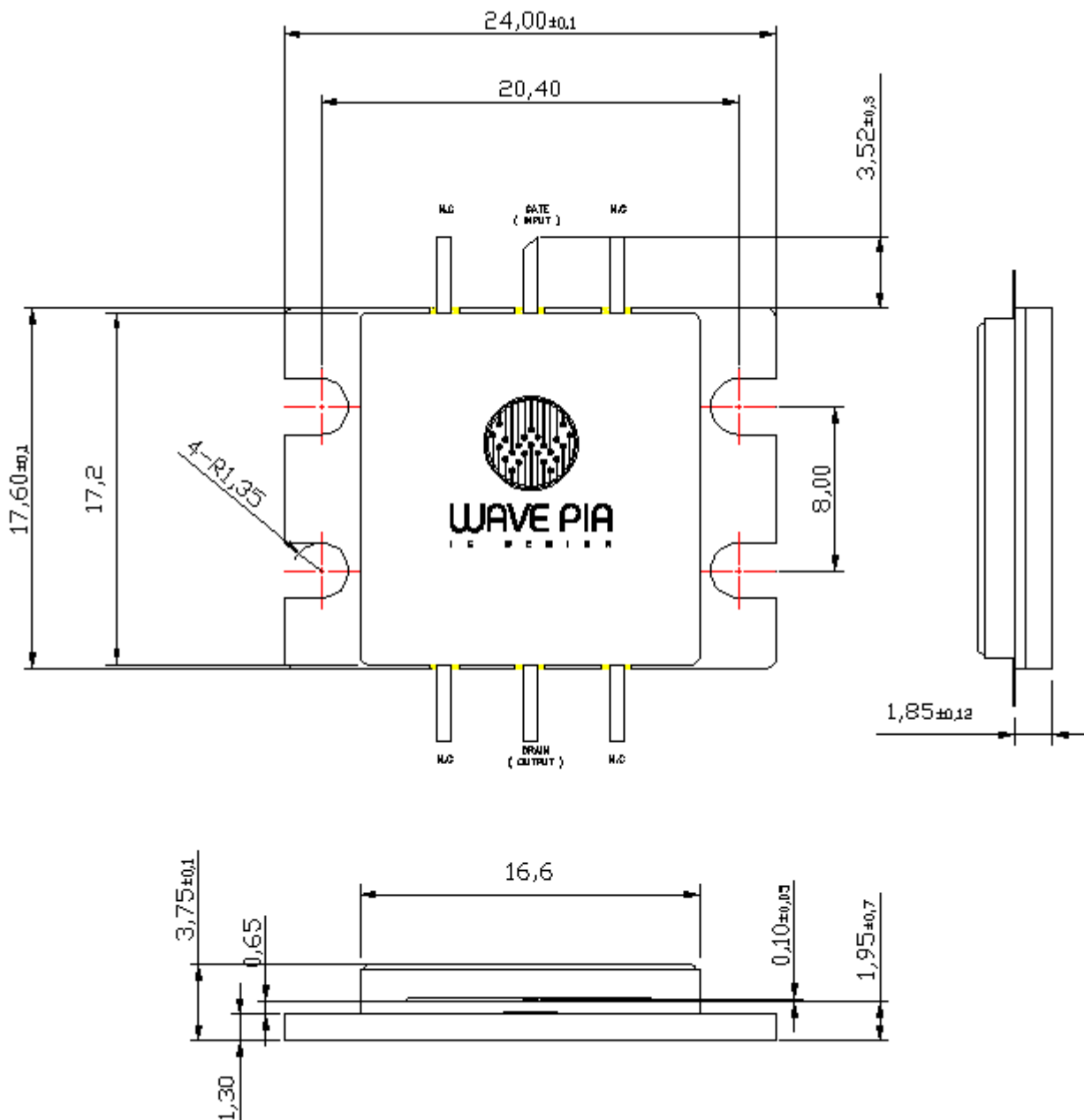
### Evaluation Board



Reference Number	Value	Items	Package	Manufacturer
C1	0.5pF	High Q Capacitor	2012	Johanson
C3	10pF	Ceramic Capacitor	2012	Samsung
C4	150pF	Ceramic Capacitor	2012	Samsung
C6	1nF	Ceramic Capacitor	2012	Samsung
C8	150pF	High Q Capacitor	2012	Johanson
C7	1pF	High Q Capacitor	2012	Johanson
C9	220pF	High Q Capacitor	2012	Johanson
C10	470nF	High Voltage Capacitor	4532	Johanson Dielectrics
C11	10uF/25V	Tantalum Capacitor	6032	Samsung
C12	10uF/75V	Tantalum Capacitor	R	Vishay
R1	10 ohm	Chip Resistor	1608	Samsung
C13,C14	N.C			
TR1		WP286P20020MH	680MH	WAVEPIA
PCB	RO4350B 30mil 1oz			Rogers

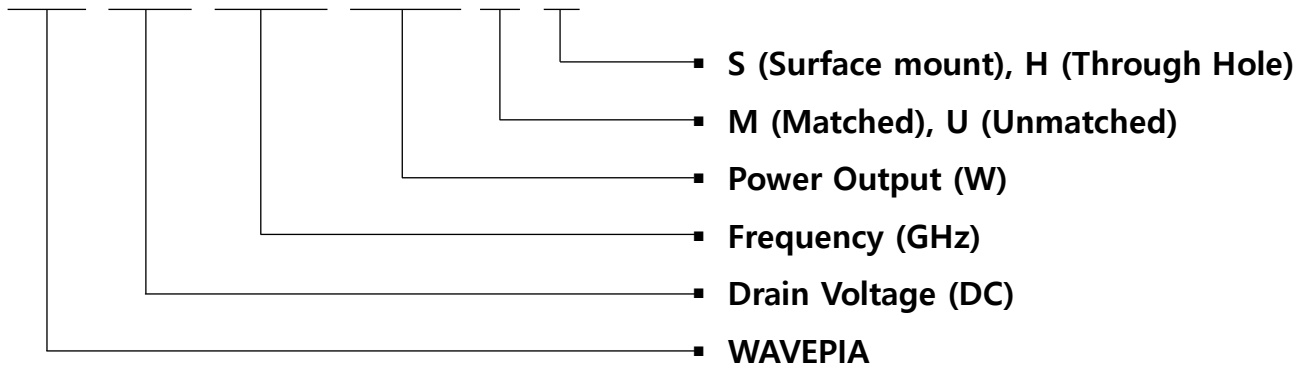
### Product Dimension

- Package Type: 680MH (Through hole)
- Unit: mm



### Part Number System

**W P 2 8 6 P 2 0 2 0 M H**



Parameter	Value	Units
Drain Voltage	28	V
Lower Frequency	5.7	GHz
Upper Frequency	6.7	GHz
Output Power	20	W
Transistor Type	Matched	-
Package	H: Through hole	-